# PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Keiichiro Oishi	08/06/2010
Kazumasa Hori	08/05/2010

#### RECEIVING PARTY DATA

Name:	Mitsubishi Shindoh Co., Ltd.	
Street Address:	4-7-35 Kita-shinagawa, Shinagawa-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	140-8550	

Name:	Mitsubishi Materials Corporation	
Street Address:	3-2, Otemachi 1-chome, Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	100-8117	

### PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12919206	

#### **CORRESPONDENCE DATA**

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PATENT

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ATTORNEY DOCKET NUMBER:	MAKOTO0003	
NAME OF SUBMITTER:	Bridget Devlin Burke	
Total Attachments: 1 source=10-12-21 Assignment#page1.tif		

PATENT REEL: 025533 FRAME: 0326

# ASSIGNMENT

The undersigned (hereinafter collectively referred to as "ASSIGNOR"), in consideration of the sum of Ten Dollars (\$10.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, hereby sells, assigns and transfers to

1) Mitsubishi Shindoh Co., Ltd. 2) Mitsubishi Materials Corporation

(Name of Assignee)

(hereinafter referred to as "ASSIGNEE"), of

1) 4-7-35, Kita-shinagawa, Shinagawa-ku, Tokyo 140-8550, JAPAN 2) 3-2, Otemachi 1-chome, Chiyoda-ku, Tokyo 100-8117, JAPAN

the entire right, title and interest for the United States of America as defined in 35 U.S.C. §100, in the invention (hereinafter "INVENTION") entitled:

# HIGH STRENGTH AND HIGH CONDUCTIVITY COPPER ALLOY ROD OR WIRE

(Type in Title of Invention)

for which Assignor has execute	ed an application for United States Pat	ent		
[ ] on this date (check	if assignment and application are exec	cuted on same date)		
[] filed on [	d on [ ] (check if Assignment is executed after application)			
as United States Patent	Application No	vn)		
and reissues thereof, and all res ASSIGNOR hereby ag successors, assigns and legal re protection of and title in and to ASSIGNOR hereby au ASSIGNMENT any further inf	ENTION, including any and all divisisulting patents on the INVENTION; rees to testify and to execute any paper spresentatives, deemed essential by AS the INVENTION hereby transferred; thorizes Joerg-Uwe Szipl and Griffin a formation necessary or desirable for re-	rs for ASSIGNEE, its SIGNEE to ASSIGNEE'S full and & Szipl, P.C. to insert in this cordation.		
Full Name of the Inventor(s) (Please type)	Signature	Date Signed		
(1) Keiichiro OISHI	Lauding Hisle	August 6,20/0		
(2) Kazumasa HORI	班加维	August 6,2010 August 5,2010		
(3)				
(4)				
(5)				
(6)	-			

[ ] Check if additional pages are attached.

Revised July 2005

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**RECORDED: 12/21/2010** 

<sup>\*</sup> For use with non-U.S. inventors.